MMBZ5221BW - MMBZ5259BW

200mW SURFACE MOUNT ZENER DIODE

Lead-free Green

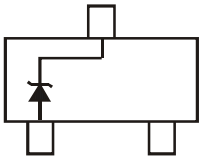
Features

- Small Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

Top View



Device Schematic

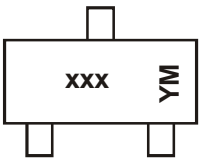
Ordering Information (Note 4)

Device	Packaging	Shipping
(Type Number)-7-F*	SOT323	3000/Tape & Reel

* Add "-7-F" to the appropriate type number in Electrical Characteristics Table from Page 2. Example: 6.2V Zener = MMBZ5234BW-7-F.

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information (Note 5)



xxx = Product Type Marking Code
(See Electrical Characteristics Table)
YM = Date Code Marking
Y = Year (ex: B = 2014)
M = Month (ex: 9 = September)

Date Code Key

Year	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	U	V	W	X	Y	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Note: 5. Product manufactured with date code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to date code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Forward Voltage	@ I_F = 10mA	V_F	0.9	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	200	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{\theta JA}$	625	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

Notes: 6. Mounted on FR4 PC Board with recommended pad layout which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Type Number	Marking Code	Zener Voltage Range (Note 7)			Test Current	Maximum Zener Impedance (Note 8)		Maximum Reverse Leakage Current (Note 7)	
		V_Z @ I_{ZT}			I_{ZT}	Z_{ZT} @ I_{ZT}	Z_{ZK} @ I_{ZK} = 0.25mA	I_R	@ V_R
		Nom (V)	Min (V)	Max (V)	mA	Ω		µA	V
MMBZ5221BW	KC1	2.4	2.28	2.52	20	30	1200	100	1.0
MMBZ5223BW	KC3	2.7	2.57	2.84	20	30	1300	75	1.0
MMBZ5225BW	KC5	3.0	2.85	3.15	20	30	1600	50	1.0
MMBZ5226BW	KG1	3.3	3.14	3.47	20	28	1600	25	1.0
MMBZ5227BW	KG2	3.6	3.42	3.78	20	24	1700	15	1.0
MMBZ5228BW	KG3	3.9	3.71	4.10	20	23	1900	10	1.0
MMBZ5229BW	KG4	4.3	4.09	4.52	20	22	2000	5.0	1.0
MMBZ5230BW	KG5	4.7	4.47	4.94	20	19	1900	5.0	2.0
MMBZ5231BW	KE1	5.1	4.85	5.36	20	17	1600	5.0	2.0
MMBZ5232BW	KE2	5.6	5.32	5.88	20	11	1600	5.0	3.0
MMBZ5233BW	KE3	6	5.70	6.30	20	7.0	1600	5.0	3.5
MMBZ5234BW	KE4	6.2	5.89	6.51	20	7.0	1000	5.0	4.0
MMBZ5235BW	KE5	6.8	6.46	7.14	20	5.0	750	3.0	5.0
MMBZ5236BW	KF1	7.5	7.13	7.88	20	6.0	500	3.0	6.0
MMBZ5237BW	KF2	8.2	7.79	8.61	20	8.0	500	3.0	6.5
MMBZ5238BW	KF3	8.7	8.27	9.14	20	8	600	3	6.5
MMBZ5239BW	KF4	9.1	8.65	9.56	20	10	600	3.0	7.0
MMBZ5240BW	KF5	10	9.50	10.50	20	17	600	3.0	8.0
MMBZ5241BW	KH1	11	10.45	11.55	20	22	600	2.0	8.4
MMBZ5242BW	KH2	12	11.40	12.60	20	30	600	1.0	9.1
MMBZ5243BW	KH3	13	12.35	13.65	9.5	13	600	0.5	9.9
MMBZ5245BW	KH5	15	14.25	15.75	8.5	16	600	0.1	11
MMBZ5246BW	KJ1	16	15.20	16.80	7.8	17	600	0.1	12
MMBZ5248BW	KJ3	18	17.10	18.90	7.0	21	600	0.1	14
MMBZ5250BW	KJ5	20	19.00	21.00	6.2	25	600	0.1	15
MMBZ5251BW	KK1	22	20.90	23.10	5.6	29	600	0.1	17
MMBZ5252BW	KK2	24	22.80	25.20	5.2	33	600	0.1	18
MMBZ5254BW	KK4	27	25.65	28.35	5.0	41	600	0.1	21
MMBZ5255BW	KK5	28	26.60	29.40	4.5	44	600	0.1	21
MMBZ5256BW	KM1	30	28.50	31.50	4.2	49	600	0.1	23
MMBZ5257BW	KM2	33	31.35	34.65	3.8	58	700	0.1	25
MMBZ5258BW	KM3	36	34.20	37.80	3.4	70	700	0.1	27
MMBZ5259BW	KM4	39	37.05	40.95	3.2	80	800	0.1	30

Notes: 7. Short duration pulse test used to minimize self-heating effect.
8. f = 1KHz.

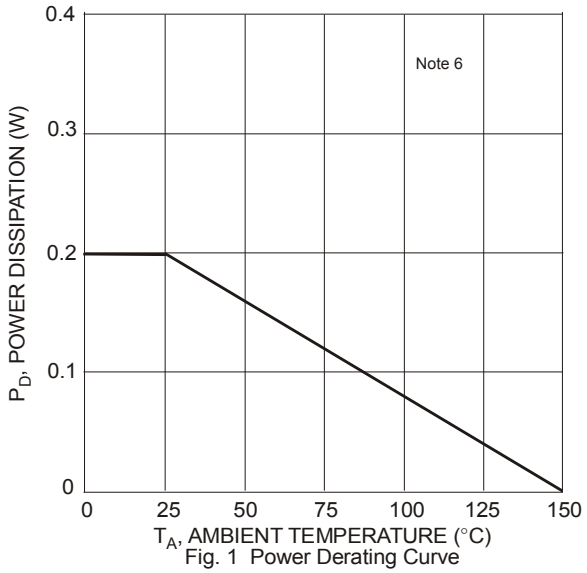


Fig. 1 Power Derating Curve

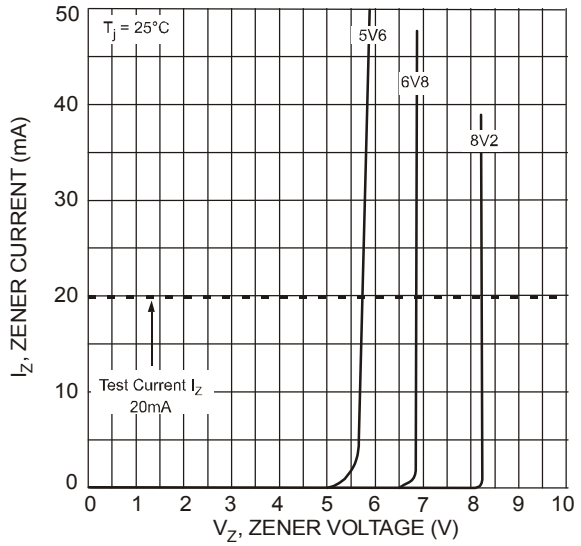


Fig. 2 Typical Zener Breakdown Characteristics

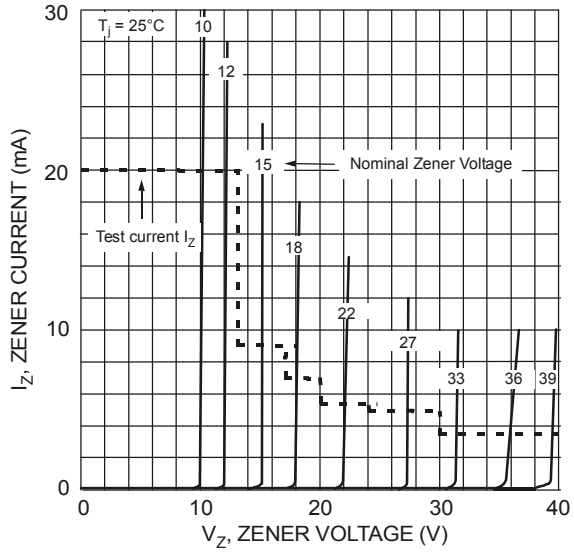


Fig. 3 Typical Zener Breakdown Characteristics

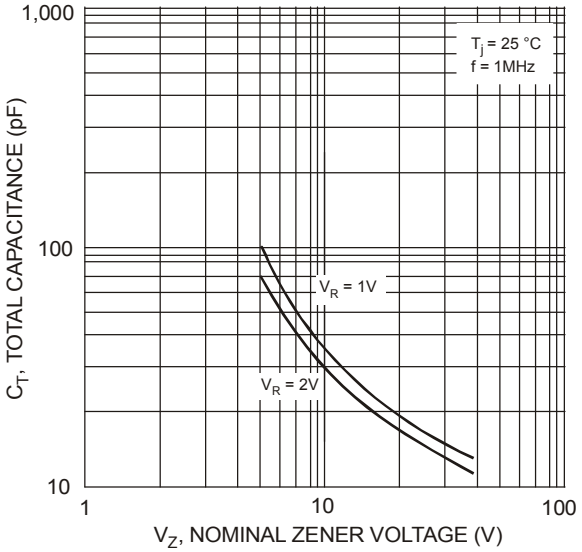


Fig. 4 Typical Total Capacitance vs. Nominal Zener Voltage

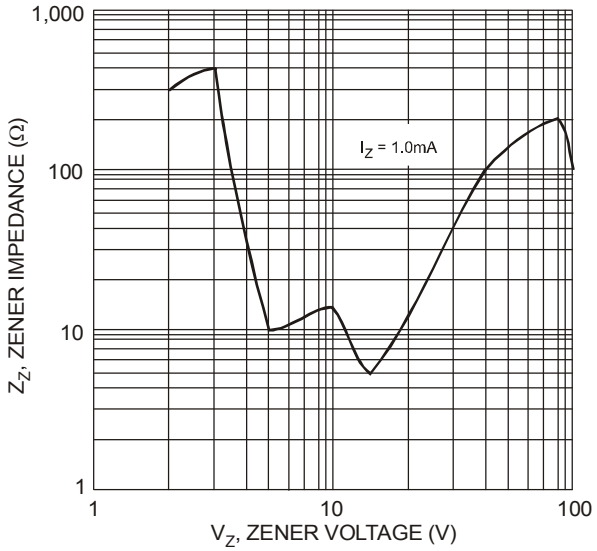


Fig. 5 Typical Zener Impedence Characteristics

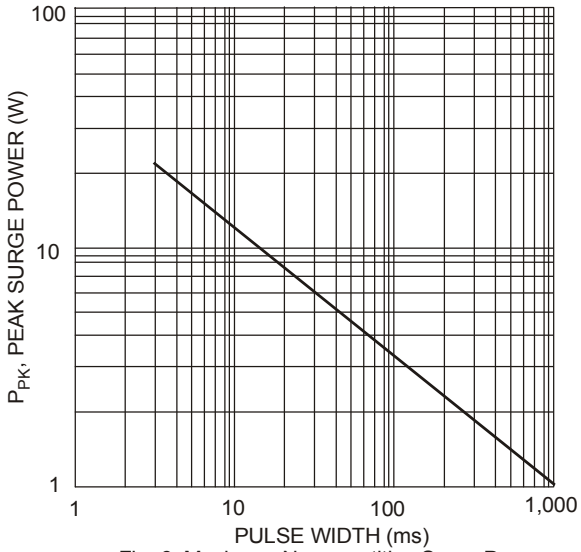
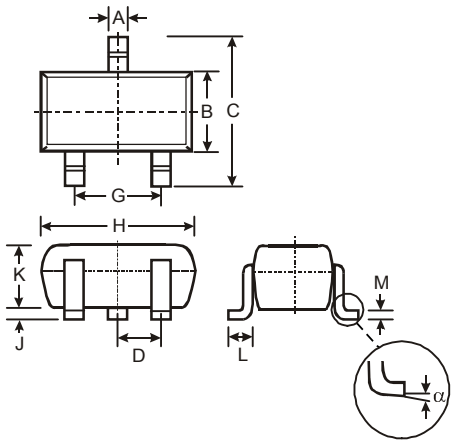


Fig. 6 Maximum Non-repetitive Surge Power

Package Outline Dimensions

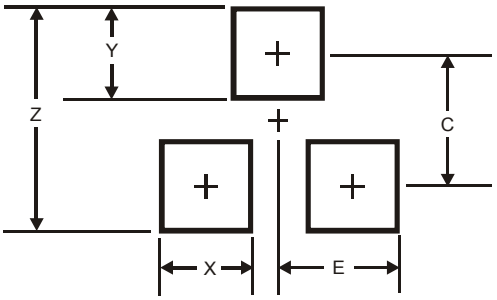
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT323			
Dim	**Min**	**Max**	**Typ**
A	0.25	0.40	0.30
B	1.15	1.35	1.30
C	2.00	2.20	2.10
D	-	-	0.65
G	1.20	1.40	1.30
H	1.80	2.20	2.15
J	0.0	0.10	0.05
K	0.90	1.00	1.00
L	0.25	0.40	0.30
M	0.10	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	2.8
X	0.7
Y	0.9
C	1.9
E	1.0

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